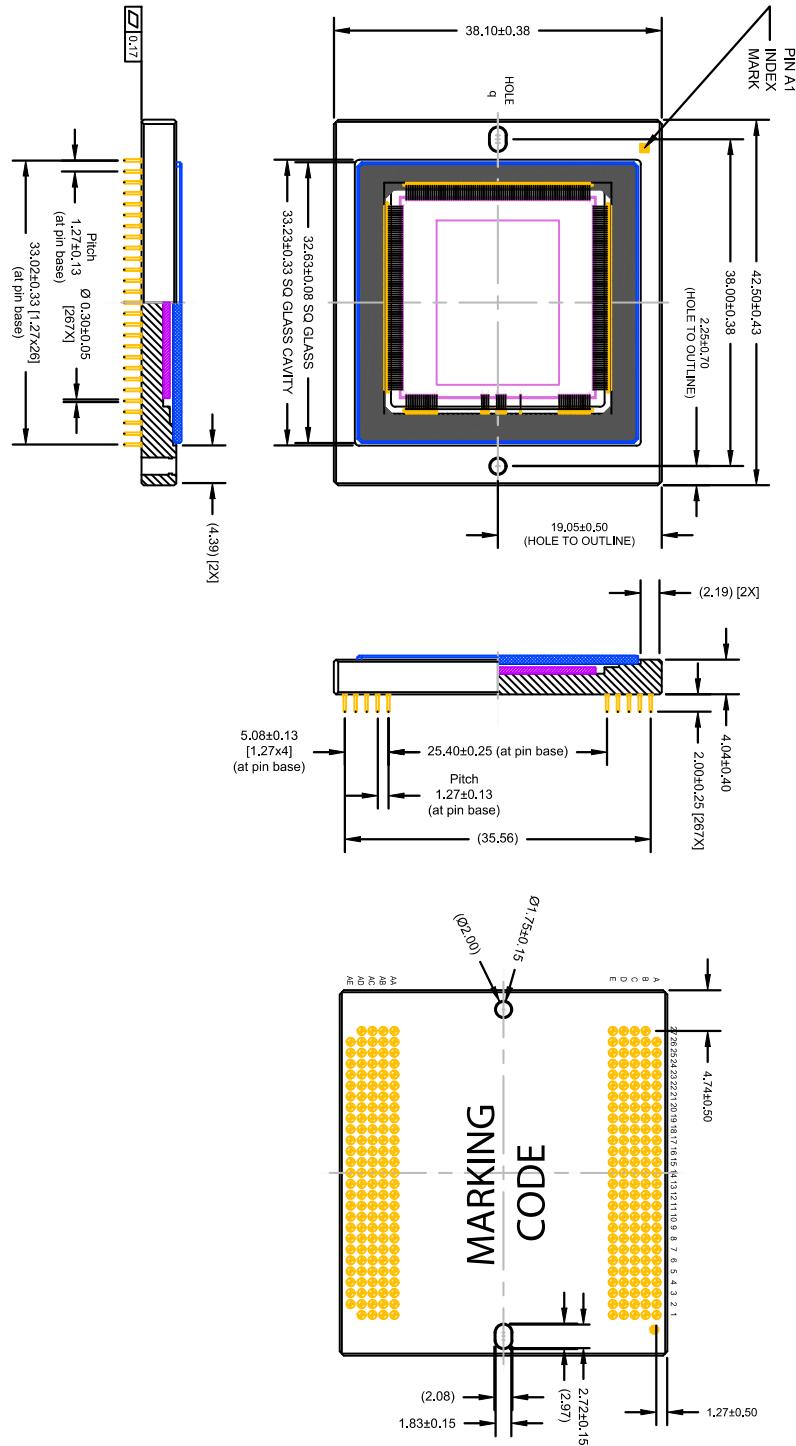


CPGA267, 42.5x42.5  
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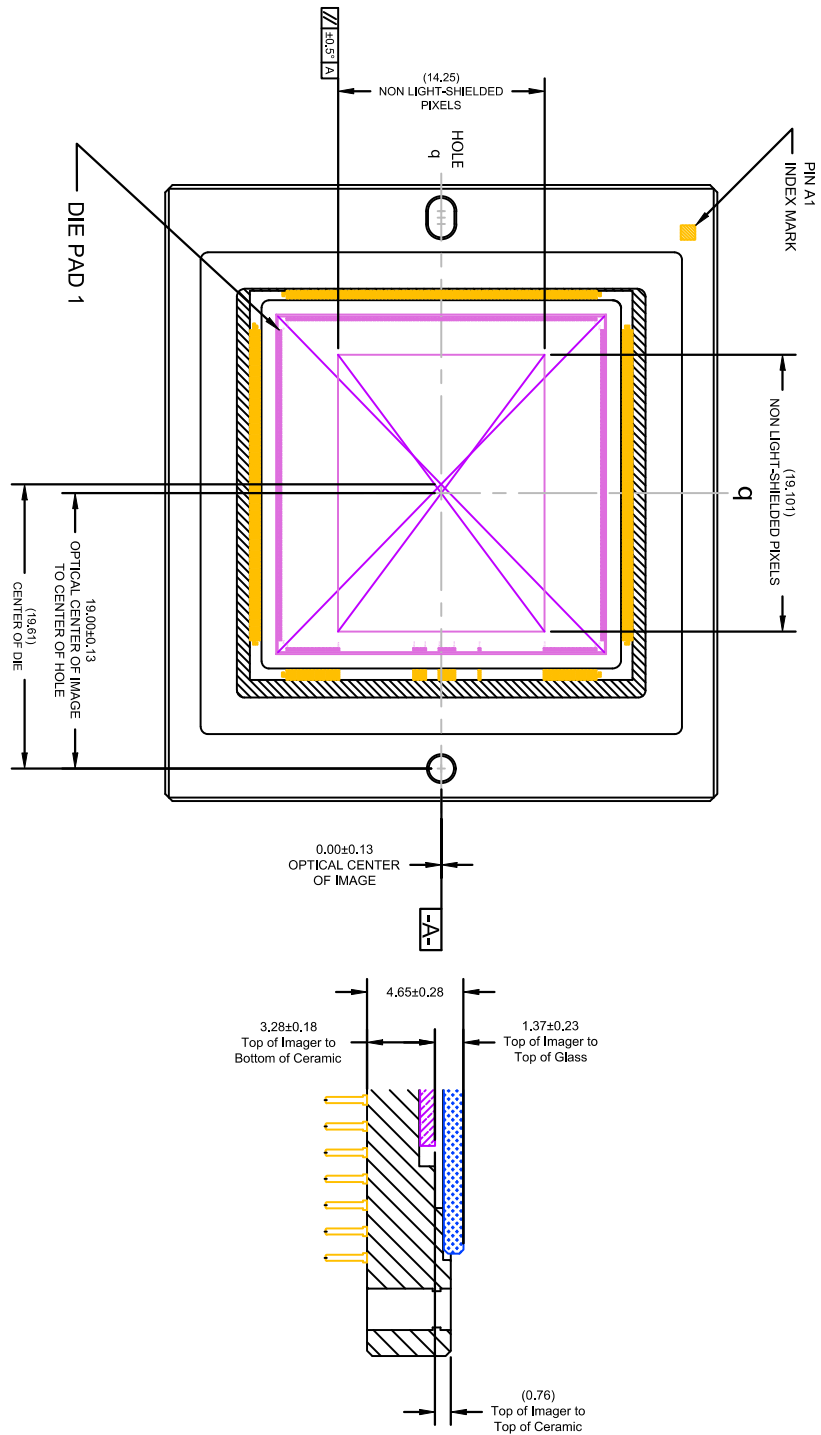
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<b>DESCRIPTION:</b>	<b>CPGA267, 42.5x42.5</b>	<b>PAGE 1 OF 2</b>

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- NOTES:
1. Die is thickness of standard 150mm WAFER: 0.725 ± 0.020 mm.
  2. Imager is stepped (23.465, 22.820) mm on wafer.
  3. Singulated die size is approximately 23.415 x 22.770 mm assuming a 50  $\mu$ m kerf.
  4. The active image array excluding dark pixels is 19.101 x 14.250 mm.
  5. The center of the die is shifted (+0.605, 0) mm to place the optical center of the image at the center of the package.



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